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#### What is "Embedded - Microcontrollers"?

"Embedded - Microcontrollers" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

#### Applications of "<u>Embedded -</u> <u>Microcontrollers</u>"

#### Details

E-XF

Product Status	Active
Core Processor	ARM® Cortex®-M0+
Core Size	32-Bit Single-Core
Speed	48MHz
Connectivity	I <sup>2</sup> C, SCI, SPI, UART/USART, USB
Peripherals	Brown-out Detect/Reset, DMA, I <sup>2</sup> S, POR, PWM, WDT
Number of I/O	26
Program Memory Size	16KB (16K x 8)
Program Memory Type	FLASH
EEPROM Size	-
RAM Size	4K x 8
Voltage - Supply (Vcc/Vdd)	2.7V ~ 3.63V
Data Converters	A/D 10x12b; D/A 1x10b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 105°C (TA)
Mounting Type	Surface Mount
Package / Case	32-TQFP
Supplier Device Package	32-TQFP (7x7)
Purchase URL	https://www.e-xfl.com/product-detail/microchip-technology/atsamda1e14b-abt

Email: info@E-XFL.COM

Address: Room A, 16/F, Full Win Commercial Centre, 573 Nathan Road, Mongkok, Hong Kong

## 6. Signal Descriptions List

The following table gives details on signal names classified by peripheral.

Signal Name	Function	Туре	Active Level				
Analog Comparators - AC							
AIN[3:0]	AC Analog Inputs	Analog					
CMP[:0]	AC Comparator Outputs	Digital					
Analog Digital	Converter - ADC						
AIN[19:0]	ADC Analog Inputs	Analog					
VREFA	ADC Voltage External Reference A	Analog					
VREFB	ADC Voltage External Reference B	Analog					
Digital Analog	Converter - DAC						
VOUT	DAC Voltage output	Analog					
VREFA	DAC Voltage External Reference	Analog					
External Interru	upt Controller						
EXTINT[15:0]	External Interrupts	Input					
NMI	External Non-Maskable Interrupt	Input					
Generic Clock	Generator - GCLK						
GCLK_IO[7:0]	Generic Clock (source clock or generic clock generator output)	I/O					
Inter-IC Sound	Controller - I2S						
MCK[1:0]	Master Clock	I/O					
SCK[1:0]	Serial Clock	I/O					
FS[1:0]	I2S Word Select or TDM Frame Sync	I/O					
SD[1:0]	Serial Data Input or Output	I/O					
Power Manage	er - PM	·					
RESETN	Reset	Input	Low				
Serial Commun	nication Interface - SERCOMx	·					
PAD[3:0]	SERCOM I/O Pads	I/O					
System Contro	I - SYSCTRL	·					
XIN	Crystal Input	Analog/ Digital					
XIN32	32kHz Crystal Input	Analog/ Digital					
XOUT	Crystal Output	Analog					
XOUT32	32kHz Crystal Output	Analog					

Peripheral Source	NVIC Line
AC – Analog Comparator	24
DAC – Digital-to-Analog Converter	25
PTC – Peripheral Touch Controller	26
I2S - Inter IC Sound	27

### 13.3 Micro Trace Buffer

### 13.3.1 Features

- Program flow tracing for the Cortex-M0+ processor
- MTB SRAM can be used for both trace and general purpose storage by the processor
- The position and size of the trace buffer in SRAM is configurable by software
- CoreSight compliant

### 13.3.2 Overview

When enabled, the MTB records changes in program flow, reported by the Cortex-M0+ processor over the execution trace interface shared between the Cortex-M0+ processor and the CoreSight MTB-M0+. This information is stored as trace packets in the SRAM by the MTB. An off-chip debugger can extract the trace information using the Debug Access Port to read the trace information from the SRAM. The debugger can then reconstruct the program flow from this information.

The MTB simultaneously stores trace information into the SRAM, and gives the processor access to the SRAM. The MTB ensures that trace write accesses have priority over processor accesses.

The execution trace packet consists of a pair of 32-bit words that the MTB generates when it detects the processor PC value changes non-sequentially. A non-sequential PC change can occur during branch instructions or during exception entry. See the CoreSight MTB-M0+ Technical Reference Manual for more details on the MTB execution trace packet format.

Tracing is enabled when the MASTER.EN bit in the Master Trace Control Register is 1. There are various ways to set the bit to 1 to start tracing, or to 0 to stop tracing. See the CoreSight Cortex-M0+ Technical Reference Manual for more details on the Trace start and stop and for a detailed description of the MTB's MASTER register. The MTB can be programmed to stop tracing automatically when the memory fills to a specified watermark level or to start or stop tracing by writing directly to the MASTER.EN bit. If the watermark mechanism is not being used and the trace buffer overflows, then the buffer wraps around overwriting previous trace packets.

The base address of the MTB registers is 0x41006000; this address is also written in the CoreSight ROM Table. The offset of each register from the base address is fixed and as defined by the CoreSight MTB-M0+ Technical Reference Manual. The MTB has 4 programmable registers to control the behavior of the trace features:

- POSITION: Contains the trace write pointer and the wrap bit,
- MASTER: Contains the main trace enable bit and other trace control fields,
- FLOW: Contains the WATERMARK address and the AUTOSTOP and AUTOHALT control bits,
- BASE: Indicates where the SRAM is located in the processor memory map. This register is provided to enable auto discovery of the MTB SRAM location, by a debug agent.

See the CoreSight MTB-M0+ Technical Reference Manual for a detailed description of these registers.

# SAM DA1

Periph.	Base	IRQ	AHB C	lock	APB C	lock	Generic Clock	PAC		Events		DMA	
Name	Address	Line	Index	Enabled	Index	Enabled	Index	Index	Prot.	User	Generator	Index	Sleep
				at Reset		at Reset			at Reset				Walking
TC5	0x42003400	20	_		13	N	28	13	N	20: EV	57: OVF 58-59: MC0-1	30: OVF 31-32: MC0-1	Y
TC6	0x42003800	21			14	N	29	14	N	21: EV	60: OVF 61-62: MC0-1	33: OVF 34-35: MC0-1	Y
TC7	0x42003C00	22			15	N	29	15	N	22: EV	63: OVF 64-65: MC0-1	36: OVF 37-38: MC0-1	Y
ADC	0x42004000	23			16	Y	30	16	N	23: START 24: SYNC	66: RESRDY 67: WINMON	39: RESRDY	Y
AC	0x42004400	24			17	N	31: DIG 32: ANA	17	N	25-26: SOC0-1	68-69: COMP0-1 70: WIN0		Y
DAC	0x42004800	25			18	N	33	18	N	27: START	71: EMPTY	40: EMPTY	Y
PTC	0x42004C00	26			19	N	34	19	N	28: STCONV	72: EOC 73: WCOMP		
12S	0x42005000	27			20	N	35-36	20	N			41:42: RX 43:44: TX	Y

Bit	31	30	29	28	27	26	25	24
				ADDOF	F[19:12]			
Access	R	R	R	R	R	R	R	R
Reset	х	x	х	x	x	x	х	x
Bit	23	22	21	20	19	18	17	16
				ADDO	FF[11:4]			
Access	R	R	R	R	R	R	R	R
Reset	х	x	x	x	x	x	x	x
Bit	15	14	13	12	11	10	9	8
		ADDO	FF[3:0]					
Access	R	R	R	R				
Reset	х	x	х	x				
Bit	7	6	5	4	3	2	1	0
							FMT	EPRES
Access							R	R
Reset							1	x

### Bits 31:12 – ADDOFF[19:0]: Address Offset

The base address of the component, relative to the base address of this ROM table.

### Bit 1 – FMT: Format

Always reads as '1', indicating a 32-bit ROM table.

#### **Bit 0 – EPRES: Entry Present**

This bit indicates whether an entry is present at this location in the ROM table.

This bit is set at power-up if the device is not protected indicating that the entry is not present.

This bit is cleared at power-up if the device is not protected indicating that the entry is present.

### 15.13.11 CoreSight ROM Table Entry 1

Name:ENTRY1Offset:0x1004 [ID-00001c14]Reset:0xXXXX00XProperty:PAC Write-Protection

### 3. Start DFLL close loop

This procedure will reduce DFLL Lock time to DFLL Fine lock time.

### **Related Links**

GCLK - Generic Clock Controller NVM Software Calibration Area Mapping

### Frequency Locking

The locking of the frequency in closed-loop mode is divided into two stages. In the first, coarse stage, the control logic quickly finds the correct value for DFLLVAL.COARSE and sets the output frequency to a value close to the correct frequency. On coarse lock, the DFLL Locked on Coarse Value bit (PCLKSR.DFLLLOCKC) in the Power and Clocks Status register will be set.

In the second, fine stage, the control logic tunes the value in DFLLVAL.FINE so that the output frequency is very close to the desired frequency. On fine lock, the DFLL Locked on Fine Value bit (PCLKSR.DFLLLOCKF) in the Power and Clocks Status register will be set.

Interrupts are generated by both PCLKSR.DFLLLOCKC and PCLKSR.DFLLLOCKF if INTENSET.DFLLOCKC or INTENSET.DFLLOCKF are written to one.

CLK\_DFLL48M is ready to be used when the DFLL Ready bit (PCLKSR.DFLLRDY) in the Power and Clocks Status register is set, but the accuracy of the output frequency depends on which locks are set. For lock times, refer to the *Electrical Characteristics*.

### **Related Links**

### Electrical Characteristics

### Frequency Error Measurement

The ratio between CLK\_DFLL48M\_REF and CLK48M\_DFLL is measured automatically when the DFLL48M is in closed-loop mode. The difference between this ratio and the value in DFLLMUL.MUL is stored in the DFLL Multiplication Ratio Difference bit group(DFLLVAL.DIFF) in the DFLL Value register. The relative error on CLK\_DFLL48M compared to the target frequency is calculated as follows:

 $\text{ERROR} = \frac{\text{DIFF}}{\text{MUL}}$ 

#### **Drift Compensation**

If the Stable DFLL Frequency bit (DFLLCTRL.STABLE) in the DFLL Control register is zero, the frequency tuner will automatically compensate for drift in the CLK\_DFLL48M without losing either of the locks. This means that DFLLVAL.FINE can change after every measurement of CLK\_DFLL48M.

The DFLLVAL.FINE value overflows or underflows can occur in close loop mode when the clock source reference drifts or is unstable. This will set the DFLL Out Of Bounds bit (PCLKSR.DFLLOOB) in the Power and Clocks Status register.

To avoid this error, the reference clock in close loop mode must be stable, an external oscillator is recommended and internal oscillator forbidden. The better choice is to use an XOSC32K.

### **Reference Clock Stop Detection**

If CLK\_DFLL48M\_REF stops or is running at a very low frequency (slower than CLK\_DFLL48M/(2 \* MUL<sub>MAX</sub>)), the DFLL Reference Clock Stopped bit (PCLKSR.DFLLRCS) in the Power and Clocks Status register will be set. Detecting a stopped reference clock can take a long time, on the order of 217 CLK\_DFLL48M cycles. When the reference clock is stopped, the DFLL48M will operate as if in open-loop mode. Closed-loop mode operation will automatically resume if the CLK\_DFLL48M\_REF is restarted. An interrupt is generated on a zero-to-one transition on PCLKSR.DFLLRCS if the DFLL Reference Clock Stopped bit (INTENSET.DFLLRCS) in the Interrupt Enable Set register is set.

## 20. WDT – Watchdog Timer

### 20.1 Overview

The Watchdog Timer (WDT) is a system function for monitoring correct program operation. It makes it possible to recover from error situations such as runaway or deadlocked code. The WDT is configured to a predefined time-out period, and is constantly running when enabled. If the WDT is not cleared within the time-out period, it will issue a system reset. An early-warning interrupt is available to indicate an upcoming watchdog time-out condition.

The window mode makes it possible to define a time slot (or window) inside the total time-out period during which the WDT must be cleared. If the WDT is cleared outside this window, either too early or too late, a system reset will be issued. Compared to the normal mode, this can also catch situations where a code error causes the WDT to be cleared frequently.

When enabled, the WDT will run in active mode and all sleep modes. It is asynchronous and runs from a CPU-independent clock source. The WDT will continue operation and issue a system reset or interrupt even if the main clocks fail.

### 20.2 Features

- Issues a system reset if the Watchdog Timer is not cleared before its time-out period
- Early Warning interrupt generation
- Asynchronous operation from dedicated oscillator
- Two types of operation:
  - Normal mode
  - Window mode
- Selectable time-out periods
  - From 8 cycles to 16,000 cycles in normal mode
  - From 16 cycles to 32,000 cycles in window mode
- Always-on capability

Bit	31	30	29	28	27	26	25	24
				CRCDAT	AIN[31:24]			
Access	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0
Bit	23	22	21	20	19	18	17	16
				CRCDAT	AIN[23:16]			
Access	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0
Bit	15	14	13	12	11	10	9	8
[				CRCDAT	AIN[15:8]			
Access	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0
Bit	7	6	5	4	3	2	1	0
[				CRCDA	TAIN[7:0]			
Access	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0

### Bits 31:0 – CRCDATAIN[31:0]: CRC Data Input

These bits store the data for which the CRC checksum is computed. A new CRC Checksum is ready (CRCBEAT+ 1) clock cycles after the CRCDATAIN register is written.

### 22.8.4 CRC Checksum

The CRCCHKSUM represents the 16- or 32-bit checksum value and the generated CRC. The register is reset to zero by default, but it is possible to reset all bits to one by writing the CRCCHKSUM register directly. It is possible to write this register only when the CRC module is disabled. If CRC-32 is selected and the CRC Status Busy flag is cleared (i.e., CRC generation is completed or aborted), the bit reversed (bit 31 is swapped with bit 0, bit 30 with bit 1, etc.) and complemented result will be read from CRCCHKSUM. If CRC-16 is selected or the CRC Status Busy flag is set (i.e., CRC generation is ongoing), CRCCHKSUM will contain the actual content.

Name:CRCCHKSUMOffset:0x08 [ID-00001ece]Reset:0x00000000Property:PAC Write-Protection, Enable-Protected

Bit	31	30	29	28	27	26	25	24	
ſ	BTCNT[15:8]								
Access	R	R	R	R	R	R	R	R	
Reset	0	0	0	0	0	0	0	0	
Bit	23	22	21	20	19	18	17	16	
				BTC	NT[7:0]				
Access	R	R	R	R	R	R	R	R	
Reset	0	0	0	0	0	0	0	0	
Bit	15	14	13	12	11	10	9	8	
	ABUSY					ID[4:0]			
Access	R		•	R	R	R	R	R	
Reset	0			0	0	0	0	0	
Bit	7	6	5	4	3	2	1	0	
ſ					LVLEXx	LVLEXx	LVLEXx	LVLEXx	
Access					R	R	R	R	
Reset					0	0	0	0	

### Bits 31:16 – BTCNT[15:0]: Active Channel Block Transfer Count

These bits hold the 16-bit block transfer count of the ongoing transfer. This value is stored in the active channel and written back in the corresponding Write-Back channel memory location when the arbiter grants a new channel access. The value is valid only when the active channel active busy flag (ABUSY) is set.

#### Bit 15 – ABUSY: Active Channel Busy

This bit is cleared when the active transfer count is written back in the write-back memory section.

This bit is set when the next descriptor transfer count is read from the write-back memory section.

#### Bits 12:8 – ID[4:0]: Active Channel ID

These bits hold the channel index currently stored in the active channel registers. The value is updated each time the arbiter grants a new channel transfer access request.

#### Bits 3,2,1,0 – LVLEXx: Level x Channel Trigger Request Executing [x=3..0]

This bit is set when a level-x channel trigger request is executing or pending.

This bit is cleared when no request is pending or being executed.

#### 22.8.15 Descriptor Memory Section Base Address

Name:BASEADDROffset:0x34 [ID-00001ece]Reset:0x00000000Property:PAC Write-Protection, Enable-Protected

### Bits 6:5 – LVL[1:0]: Channel Arbitration Level

These bits define the arbitration level used for the DMA channel, where a high level has priority over a low level. For further details on arbitration schemes, refer to Arbitration.

These bits are not enable-protected.

TRIGACT[1:0]	Name	Description
0x0	LVL0	Channel Priority Level 0
0x1	LVL1	Channel Priority Level 1
0x2	LVL2	Channel Priority Level 2
0x3	LVL3	Channel Priority Level 3

### Bit 4 – EVOE: Channel Event Output Enable

This bit indicates if the Channel event generation is enabled. The event will be generated for every condition defined in the descriptor Event Output Selection (BTCTRL.EVOSEL).

This bit is available only for the least significant DMA channels. Refer to table: User Multiplexer Selection and Event Generator Selection of the Event System for details.

Value	Description
0	Channel event generation is disabled.
1	Channel event generation is enabled.

### Bit 3 – EVIE: Channel Event Input Enable

This bit is available only for the least significant DMA channels. Refer to table: *User Multiplexer Selection* and *Event Generator Selection* of the Event System for details.

Value	Description
0	Channel event action will not be executed on any incoming event.
1	Channel event action will be executed on any incoming event.

### Bits 2:0 – EVACT[2:0]: Event Input Action

These bits define the event input action, as shown below. The action is executed only if the corresponding EVIE bit in CHCTRLB register of the channel is set.

These bits are available only for the least significant DMA channels. Refer to table: *User Multiplexer Selection* and *Event Generator Selection* of the Event System for details.

EVACT[2:0]	Name	Description
0x0	NOACT	No action
0x1	TRIG	Normal Transfer and Conditional Transfer on Strobe trigger
0x2	CTRIG	Conditional transfer trigger
0x3	CBLOCK	Conditional block transfer
0x4	SUSPEND	Channel suspend operation
0x5	RESUME	Channel resume operation

### 22.8.21 Channel Interrupt Enable Set

This register allows the user to enable an interrupt without doing a read-modify-write operation. Changes in this register will also be reflected in the Channel Interrupt Enable Clear (CHINTENCLR) register. This register affects the DMA channel that is selected in the Channel ID register (CHID.ID).

Name:CHINTENSETOffset:0x4D [ID-00001ece]Reset:0x00Property:PAC Write-Protection

Bit	7	6	5	4	3	2	1	0
						SUSP	TCMPL	TERR
Access						R/W	R/W	R/W
Reset						0	0	0

### Bit 2 – SUSP: Channel Suspend Interrupt Enable

Writing a '0' to this bit has no effect.

Writing a '1' to this bit will set the Channel Suspend Interrupt Enable bit, which enables the Channel Suspend interrupt.

Value	Description
0	The Channel Suspend interrupt is disabled.
1	The Channel Suspend interrupt is enabled.

### Bit 1 – TCMPL: Channel Transfer Complete Interrupt Enable

Writing a '0' to this bit has no effect.

Writing a '1' to this bit will set the Channel Transfer Complete Interrupt Enable bit, which enables the Channel Transfer Complete interrupt.

Value	Description
0	The Channel Transfer Complete interrupt is disabled.
1	The Channel Transfer Complete interrupt is enabled.

#### Bit 0 – TERR: Channel Transfer Error Interrupt Enable

Writing a '0' to this bit has no effect.

Writing a '1' to this bit will set the Channel Transfer Error Interrupt Enable bit, which enables the Channel Transfer Error interrupt.

Value	Description
0	The Channel Transfer Error interrupt is disabled.
1	The Channel Transfer Error interrupt is enabled.

### 22.8.22 Channel Interrupt Flag Status and Clear

This register affects the DMA channel that is selected in the Channel ID register (CHID.ID).

## 23. EIC – External Interrupt Controller

### 23.1 Overview

The External Interrupt Controller (EIC) allows external pins to be configured as interrupt lines. Each interrupt line can be individually masked and can generate an interrupt on rising, falling, or both edges, or on high or low levels. Each external pin has a configurable filter to remove spikes. Each external pin can also be configured to be asynchronous in order to wake up the device from sleep modes where all clocks have been disabled. External pins can also generate an event.

A separate non-maskable interrupt (NMI) is also supported. It has properties similar to the other external interrupts, but is connected to the NMI request of the CPU, enabling it to interrupt any other interrupt mode.

### 23.2 Features

- Up to 16 external pins, plus one non-maskable pin
- Dedicated, individually maskable interrupt for each pin
- Interrupt on rising, falling, or both edges
- Interrupt on high or low levels
- Asynchronous interrupts for sleep modes without clock
- Filtering of external pins
- Event generation

### 23.3 Block Diagram

### Figure 23-1. EIC Block Diagram



## 24. NVMCTRL – Non-Volatile Memory Controller

### 24.1 Overview

Non-Volatile Memory (NVM) is a reprogrammable Flash memory that retains program and data storage even with power off. It embeds a main array and a separate smaller array intended for EEPROM emulation (RWWEE) that can be programmed while reading the main array. The NVM Controller (NVMCTRL) connects to the AHB and APB bus interfaces for system access to the NVM block. The AHB interface is used for reads and writes to the NVM block, while the APB interface is used for commands and configuration.

### 24.2 Features

- 32-bit AHB interface for reads and writes
- Read While Write EEPROM emulation area
- All NVM sections are memory mapped to the AHB, including calibration and system configuration
- 32-bit APB interface for commands and control
- Programmable wait states for read optimization
- 16 regions can be individually protected or unprotected
- Additional protection for boot loader
- Supports device protection through a security bit
- Interface to Power Manager for power-down of Flash blocks in sleep modes
- · Can optionally wake up on exit from sleep or on first access
- Direct-mapped cache

**Note:** A register with property "Enable-Protected" may contain bits that are *not* enable-protected.

### 24.3 Block Diagram

### Figure 24-1. Block Diagram



## 25. PORT - I/O Pin Controller

### 25.1 Overview

The IO Pin Controller (PORT) controls the I/O pins of the device. The I/O pins are organized in a series of groups, collectively referred to as a PORT group. Each PORT group can have up to 32 pins that can be configured and controlled individually or as a group. The number of PORT groups on a device may depend on the package/number of pins. Each pin may either be used for general-purpose I/O under direct application control or be assigned to an embedded device peripheral. When used for general-purpose I/O, each pin can be configured as input or output, with highly configurable driver and pull settings.

All I/O pins have true read-modify-write functionality when used for general-purpose I/O; the direction or the output value of one or more pins may be changed (set, reset or toggled) explicitly without unintentionally changing the state of any other pins in the same port group by a single, atomic 8-, 16- or 32-bit write.

The PORT is connected to the high-speed bus matrix through an AHB/APB bridge.

### 25.2 Features

- Selectable input and output configuration for each individual pin
- Software-controlled multiplexing of peripheral functions on I/O pins
- Flexible pin configuration through a dedicated Pin Configuration register
- Configurable output driver and pull settings:
  - Totem-pole (push-pull)
  - Pull configuration
  - Driver strength
- Configurable input buffer and pull settings:
  - Internal pull-up or pull-down
  - Input sampling criteria
  - Input buffer can be disabled if not needed for lower power consumption
- Power saving using STANDBY mode
  - No access to configuration registers
  - Possible access to data registers (DIR, OUT or IN)

## **Related Links**

PORT: IO Pin Controller

### 28.5.2 Power Management

This peripheral can continue to operate in any sleep mode where its source clock is running. The interrupts can wake up the device from sleep modes.

### **Related Links**

PM - Power Manager

### 28.5.3 Clocks

The SERCOM bus clock (CLK\_SERCOMx\_APB) can be enabled and disabled in the Power Manager. Refer to *Perhipharal Clock Masking* for details and default status of this clock.

A generic clock (GCLK\_SERCOMx\_CORE) is required to clock the SERCOMx\_CORE. This clock must be configured and enabled in the Generic Clock Controller before using the SERCOMx\_CORE. Refer to *GCLK - Generic Clock Controller* for details.

This generic clock is asynchronous to the bus clock (CLK\_SERCOMx\_APB). Therefore, writing to certain registers will require synchronization to the clock domains. Refer to *Synchronization* for further details.

### **Related Links**

Synchronization GCLK - Generic Clock Controller Peripheral Clock Masking

### 28.5.4 DMA

The DMA request lines are connected to the DMA Controller (DMAC). In order to use DMA requests with this peripheral the DMAC must be configured first. Refer to *DMAC – Direct Memory Access Controller* for details.

### **Related Links**

DMAC – Direct Memory Access Controller

### 28.5.5 Interrupts

The interrupt request line is connected to the Interrupt Controller. In order to use interrupt requests of this peripheral, the Interrupt Controller (NVIC) must be configured first. Refer to *Nested Vector Interrupt Controller* for details.

### **Related Links**

Nested Vector Interrupt Controller

### 28.5.6 Events

Not applicable.

### 28.5.7 Debug Operation

When the CPU is halted in debug mode, this peripheral will continue normal operation. If the peripheral is configured to require periodical service by the CPU through interrupts or similar, improper operation or data loss may result during debugging. This peripheral can be forced to halt operation during debugging - refer to the Debug Control (DBGCTRL) register for details.

### 28.5.8 Register Access Protection

Registers with write-access can be write-protected optionally by the peripheral access controller (PAC).

When the CPU is halted in debug mode, all write-protection is automatically disabled. Write-protection does not apply for accesses through an external debugger.

31.5.9 Analog Connections

Not applicable.

### 31.6 Functional Description

### 31.6.1 Principle of Operation

The I<sup>2</sup>S uses three or four communication lines for synchronous data transfer:

- SDm for receiving or transmitting in Serializer m (m=0..1)
- SCKn for the serial clock in Clock Unit n (n=0..1)
- FSn for the frame synchronization or I<sup>2</sup>S word select, identifying the beginning of each frame
- Optionally, MCKn to output an oversampling clock to an external codec

I<sup>2</sup>S data transfer is frame based, where a serial frame:

- Starts with the frame synchronization active edge, and
- Consists of 1 to 8 data slots, that are 8-, 16-, 24-, or 32-bit wide.

Each data slot is used to transfer one data sample of 8, 16, 18, 20, 24 or 32 bits.

Frame based data transfer is described in the following figure:

### Figure 31-2. Data Format: Frames, Slot, Bits and Clocks



I<sup>2</sup>S supports multiple data formats such as:

- 32-, 24-, 20-, 18-, 16-, and 8-bit mono or stereo format
- 16- and 8-bit compact stereo format, with left and right samples packed in the same word to reduce data transfers

 For a definition of LPM Token BESL field, refer to "Table 2-3 in the reference document ENGINEERING CHANGE NOTICE, USB 2.0 Link Power Management Addendum" and "Table X-X1 in Errata for ECN USB 2.0 Link Power Management.

### Bits 3:0 – SUBPID[3:0]: SUBPID field send with extended token

These bits define the SUBPID field of a received extended token. These bits are updated when the USB has answered by an handshake token ACK to a LPM transaction. See Section 2.1.1 Protocol Extension Token in the reference document "ENGINEERING CHANGE NOTICE, USB 2.0 Link Power Management Addendum".

### 34.8.4.5 Device Status Bank

Name: STATUS\_BK Offset: 0x0A & 0x1A [ID-0000306e] Reset: 0xxxxxxx Property: NA

Bit	7	6	5	4	3	2	1	0
							ERRORFLOW	CRCERR
Access							R/W	R/W
Reset							x	x

### Bit 1 – ERRORFLOW: Error Flow Status

This bit defines the Error Flow Status.

This bit is set when a Error Flow has been detected during transfer from/towards this bank.

For OUT transfer, a NAK handshake has been sent.

For Isochronous OUT transfer, an overrun condition has occurred.

For IN transfer, this bit is not valid. EPSTATUS.TRFAIL0 and EPSTATUS.TRFAIL1 should reflect the flow errors.

Value	Description
0	No Error Flow detected.
1	A Error Flow has been detected.

### Bit 0 – CRCERR: CRC Error

This bit defines the CRC Error Status.

This bit is set when a CRC error has been detected in an isochronous OUT endpoint bank.

0.2.5 Host Registers - Common

Value	Description
0	No CRC Error.
1	CRC Error detected.

### 34.8.5 Host Registers - Common

#### 34.8.5.1 Control B

Bit	7	6	5	4	3	2	1	0
							EMPTYEO	STARTEI
Access							R/W	R/W
Reset							0	0

### Bit 1 – EMPTYEO: Data Buffer Empty Event Output

This bit indicates whether or not the Data Buffer Empty event is enabled and will be generated when the Data Buffer register is empty.

Value	Description
0	Data Buffer Empty event is disabled and will not be generated.
1	Data Buffer Empty event is enabled and will be generated.

### Bit 0 – STARTEI: Start Conversion Event Input

This bit indicates whether or not the Start Conversion event is enabled and data are loaded from the Data Buffer register to the Data register upon event reception.

Value	Description
0	A new conversion will not be triggered on any incoming event.
1	A new conversion will be triggered on any incoming event.

### 37.8.4 Interrupt Enable Clear

This register allows the user to disable an interrupt without doing a read-modify-write operation. Changes in this register will also be reflected in the Interrupt Enable Set register (INTENSET).

Name:INTENCLROffset:0x04 [ID-00000bc7]Reset:0x00Property:PAC Write-Protection

Bit	7	6	5	4	3	2	1	0
						SYNCRDY	EMPTY	UNDERRUN
Access						R/W	R/W	R/W
Reset						0	0	0

#### **Bit 2 – SYNCRDY: Synchronization Ready Interrupt Enable**

Writing a '0' to this bit has no effect.

Writing a '1' to this bit will clear the Synchronization Ready Interrupt Enable bit, which disables the Synchronization Ready interrupt.

Value	Description
0	The Synchronization Ready interrupt is disabled.
1	The Synchronization Ready interrupt is enabled.

#### Bit 1 – EMPTY: Data Buffer Empty Interrupt Enable

Writing a '0' to this bit has no effect.

Writing a '1' to this bit will clear the Data Buffer Empty Interrupt Enable bit, which disables the Data Buffer Empty interrupt.

### Table 39-36. Digital Clock Characteristics

Parameter	Conditions	Symbol	Min.	Тур.	Max.	Unit
XIN clock frequency	Digital mode	Fx <sub>in</sub>	-	-	32	MHz
XIN clock duty cycle	Digital mode	DC <sub>xin</sub>	-	-	-	%

### **39.11.1.2 XOSC Characteristics**

The following table describes the characteristics for the oscillator when a crystal is connected between XIN and XOUT. The user must choose a crystal oscillator where the crystal load capacitance CL is within the range given in the table. The exact value of CL can be found in the crystal datasheet. The capacitance of the external capacitors (CLEXT) can then be computed as follows:

 $C_{LEXT} = 2(C_L - C_{STRAY} - C_{SHUNT})$ 

where  $C_{STRAY}$  is the capacitance of the pins and PCB,  $C_{SHUNT}$  is the shunt capacitance of the crystal.

 Table 39-37. Crystal Oscillator Characteristics

Parameter	Conditions	Symbol	Min.	Тур.	Max.	Unit
Crystal oscillator frequency		f <sub>OUT</sub>	0.4	-	32	MHz
Crystal Equivalent Series Resistance Safety Factor = 3 The AGC does not have any noticeable impact on these measurements.	f = 0.455 MHz, C <sub>L</sub> = 100pF XOSC.GAIN = 0	ESR	-	-	5.6K	
	f = 2MHz, C <sub>L</sub> = 20pF XOSC.GAIN = 0		-	-	330	
	f = 4MHz, C <sub>L</sub> = 20pF XOSC.GAIN = 1		-	-	240	0
	f = 8 MHz, C <sub>L</sub> = 20pF XOSC.GAIN = 2		-	-	105	12
	$f = 16 \text{ MHz},$ $C_{L} = 20 \text{pF}$ $XOSC.GAIN = 3$		-	-	60	-
	f = 32MHz, $C_L = 18pF$ XOSC.GAIN = 4		-	-	55	
Parasitic capacitor load		C <sub>XIN</sub>	-	5.9	-	pF
Parasitic capacitor load		C <sub>XOUT</sub>	-	3.2	-	pF

Parameter	Conditions	Symbol	Min.	Тур.	Max.	Unit
	over [2.7, 3.6]V					
Current consumption	IDLE2 on OSC32K versus IDLE2 on calibrated OSC8M enabled at 8MHz (FRANGE=1, PRESC=0)	I <sub>OSC8M</sub>	-	64	96	μA
Startup time		t <sub>STARTUP</sub>	-	2.3	3.9	μs
Duty cycle		Duty	-	50	-	%

### 39.11.7 Fractional Digital Phase Locked Loop (FDPLL96M) Characteristics Table 39-45. FDPLL96M Characteristics<sup>(1)</sup> (Device Variant A / Die revision E)

Parameter	Conditions	Symbol	Min.	Тур.	Max.	Unit
Input frequency		f <sub>IN</sub>	32	-	2000	KHz
Output frequency		f <sub>OUT</sub>	48	-	96	MHz
Current consumption	$f_{IN}$ = 32kHz, $f_{OUT}$ = 48MHz	I <sub>FDPLL96M</sub>	-	500	733	μA
	$f_{IN}$ = 32kHz, $f_{OUT}$ = 96MHz		-	900	1235	
Period jitter	$f_{IN}$ = 32kHz, $f_{OUT}$ = 48MHz	Jp	-	1.3	4	%
	$f_{IN}$ = 32kHz, $f_{OUT}$ = 96MHz		-	3.1	7	
	f <sub>IN</sub> = 2MHz, f <sub>OUT</sub> = 48MHz		-	1.3	4	
	$f_{IN}$ = 2MHz, $f_{OUT}$ = 96MHz		-	3.6	9	
Lock Time	After startup, time to get lock signal. f <sub>IN</sub> = 32kHz, f <sub>OUT</sub> = 96MHz	t <sub>LOCK</sub>	-	1	2	ms
	$f_{IN}$ = 2MHz, $f_{OUT}$ = 96MHz		-	25	50	μs
Duty cycle		Duty	40	50	60	%

1. All values have been characterized with FILTSEL[1/0] as default value.

### Table 39-46. FDPLL96M Characteristics<sup>(1)</sup> (Device Variant B / Die revision F)

Parameter	Conditions	Symbol	Min.	Тур.	Max.	Unit
Input frequency		f <sub>IN</sub>	32	-	2000	KHz
Output frequency		f <sub>OUT</sub>	48	-	96	MHz
Current consumption	$f_{IN}$ = 32kHz, $f_{OUT}$ = 48MHz	I <sub>FDPLL96M</sub>	-	500	-	μA
	$f_{IN}$ = 32kHz, $f_{OUT}$ = 96MHz		-	900	-	
Period jitter	f <sub>IN</sub> = 32kHz, f <sub>OUT</sub> = 48MHz	Jp	-	2.1	4.0	%
	$f_{IN}$ = 32kHz, $f_{OUT}$ = 96MHz		-	4.0	11.0	
	f <sub>IN</sub> = 2MHz, f <sub>OUT</sub> = 48MHz		-	2.2	4.0	
	f <sub>IN</sub> = 2MHz, f <sub>OUT</sub> = 96MHz		-	4.7	12.0	

#### Errata reference: 15625 Fix/Workaround:

Do not use retrigger events/actions when TCC is configured in dithering mode.

3 – Advance capture mode (CAPTMIN CAPTMAX LOCMIN LOCMAX DERIV0) doesn't work if an upper channel is not in one of these mode. Example: when CC[0]=CAPTMIN, CC[1]=CAPTMAX, CC[2]=CAPTEN, and CC[3]=CAPTEN, CAPTMIN and CAPTMAX won't work. Errata reference: 14817

### Fix/Workaround:

Basic capture mode must be set in lower channel and advance capture mode in upper channel.

Example: CC[0]=CAPTEN , CC[1]=CAPTEN , CC[2]=CAPTMIN, CC[3]=CAPTMAX

All capture will be done as expected.